### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



2N2222; 2N2222A NPN switching transistors

Product specification Supersedes data of September 1994 File under Discrete Semiconductors, SC04 1997 May 29





### **NPN** switching transistors

2N2222; 2N2222A

### **FEATURES**

- High current (max. 800 mA)
- Low voltage (max. 40 V).

### **APPLICATIONS**

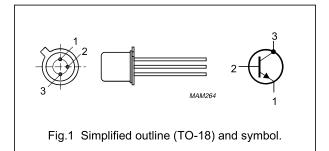
• Linear amplification and switching.

### **DESCRIPTION**

NPN switching transistor in a TO-18 metal package. PNP complement: 2N2907A.

### **PINNING**

PIN	DESCRIPTION			
1	emitter			
2	base			
3	collector, connected to case			



### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter			
	2N2222		-	60	V
	2N2222A		-	75	V
$V_{CEO}$	collector-emitter voltage	open base			
	2N2222		-	30	V
	2N2222A		-	40	V
I <sub>C</sub>	collector current (DC)		_	800	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	500	mW
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 10 mA; V <sub>CE</sub> = 10 V	75	_	
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 20 mA; V <sub>CE</sub> = 20 V; f = 100 MHz			
	2N2222		250	-	MHz
	2N2222A		300	-	MHz
t <sub>off</sub>	turn-off time	I <sub>Con</sub> = 150 mA; I <sub>Bon</sub> = 15 mA; I <sub>Boff</sub> = –15 mA	_	250	ns

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### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter			
	2N2222		-	60	V
	2N2222A		_	75	V
V <sub>CEO</sub>	collector-emitter voltage	open base			
	2N2222		-	30	V
	2N2222A		-	40	V
V <sub>EBO</sub>	emitter-base voltage	open collector			
	2N2222		-	5	V
	2N2222A		_	6	V
I <sub>C</sub>	collector current (DC)		-	800	mA
I <sub>CM</sub>	peak collector current		_	800	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	<u> </u>	500	mW
		T <sub>case</sub> ≤ 25 °C	_	1.2	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		=	200	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air	350	K/W
R <sub>th j-c</sub>	thermal resistance from junction to case		146	K/W

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### **CHARACTERISTICS**

 $T_j$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector cut-off current				
	2N2222	I <sub>E</sub> = 0; V <sub>CB</sub> = 50 V	_	10	nA
		I <sub>E</sub> = 0; V <sub>CB</sub> = 50 V; T <sub>amb</sub> = 150 °C	_	10	μΑ
I <sub>CBO</sub>	collector cut-off current				
	2N2222A	I <sub>E</sub> = 0; V <sub>CB</sub> = 60 V	-	10	nA
		I <sub>E</sub> = 0; V <sub>CB</sub> = 60 V; T <sub>amb</sub> = 150 °C	_	10	μΑ
I <sub>EBO</sub>	emitter cut-off current	I <sub>C</sub> = 0; V <sub>EB</sub> = 3 V	_	10	nA
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 0.1 mA; V <sub>CE</sub> = 10 V	35	-	
		I <sub>C</sub> = 1 mA; V <sub>CE</sub> = 10 V	50	<u> </u>	
		I <sub>C</sub> = 10 mA; V <sub>CE</sub> = 10 V	75	<u> </u>	
		I <sub>C</sub> = 150 mA; V <sub>CE</sub> = 1 V; note 1	50	<u> </u>	
		I <sub>C</sub> = 150 mA; V <sub>CE</sub> = 10 V; note 1	100	300	
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 10 mA; V <sub>CE</sub> = 10 V; T <sub>amb</sub> = -55 °C			
	2N2222A		35	-	
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 500 mA; V <sub>CE</sub> = 10 V; note 1			
	2N2222		30	-	
	2N2222A		40	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage				
	2N2222	$I_C = 150 \text{ mA}; I_B = 15 \text{ mA}; \text{ note 1}$	-	400	mV
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	_	1.6	٧
V <sub>CEsat</sub>	collector-emitter saturation voltage				
	2N2222A	$I_C$ = 150 mA; $I_B$ = 15 mA; note 1	-	300	mV
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	_	1	٧
V <sub>BEsat</sub>	base-emitter saturation voltage				
	2N2222	I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1	-	1.3	٧
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	_	2.6	٧
V <sub>BEsat</sub>	base-emitter saturation voltage				
	2N2222A	I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1	0.6	1.2	٧
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	_	2	٧
C <sub>c</sub>	collector capacitance	I <sub>E</sub> = i <sub>e</sub> = 0; V <sub>CB</sub> = 10 V; f = 1 MHz	_	8	pF
C <sub>e</sub>	emitter capacitance	I <sub>C</sub> = i <sub>c</sub> = 0; V <sub>EB</sub> = 500 mV; f = 1 MHz			
	2N2222A		-	25	pF
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 20 mA; V <sub>CE</sub> = 20 V; f = 100 MHz			
	2N2222		250	-	MHz
	2N2222A		300	-	MHz
F	noise figure	$I_C$ = 200 μA; $V_{CE}$ = 5 V; $R_S$ = 2 kΩ;			
	2N2222A	f = 1 kHz; B = 200 Hz	_	4	dB

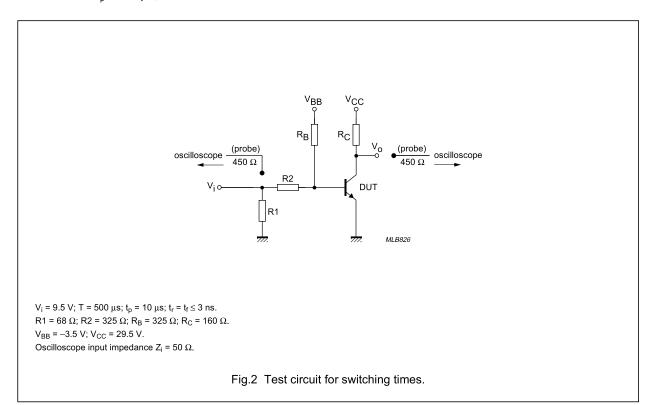
### NPN switching transistors

### 2N2222; 2N2222A

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Switching			-		
t <sub>on</sub>	turn-on time	I <sub>Con</sub> = 150 mA; I <sub>Bon</sub> = 15 mA; I <sub>Boff</sub> = -15 mA	_	35	ns
t <sub>d</sub>	delay time		_	10	ns
t <sub>r</sub>	rise time		_	25	ns
t <sub>off</sub>	turn-off time		_	250	ns
t <sub>s</sub>	storage time		_	200	ns
t <sub>f</sub>	fall time		_	60	ns

#### Note

1. Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 



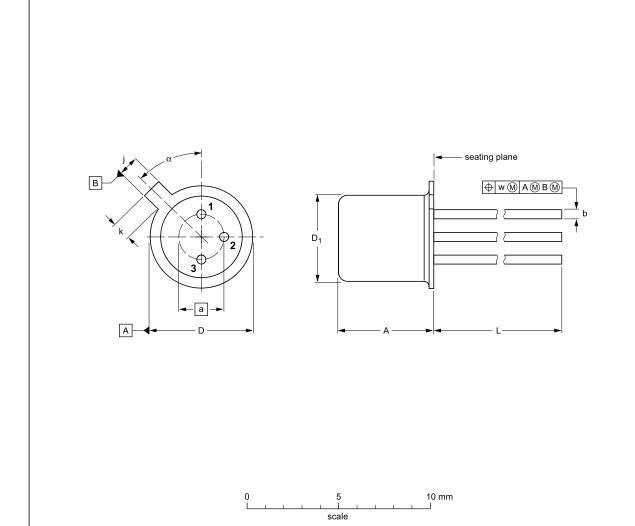
### NPN switching transistors

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### PACKAGE OUTLINE

### Metal-can cylindrical single-ended package; 3 leads

SOT18/13



### DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	А	а	b	D	D <sub>1</sub>	j	k	L	w	α
mm	5.31 4.74	2.54	0.47 0.41	5.45 5.30	4.70 4.55	1.03 0.94	1.1 0.9	15.0 12.7	0.40	45°

OUTLINE		REFERENCES				ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT18/13	B11/C7 type 3	TO-18				97-04-18

### NPN switching transistors

2N2222; 2N2222A

### **DEFINITIONS**

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.

#### **Limiting values**

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

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## Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,

Tel. +61 2 9805 4455, Fax. +61 2 9805 4466 Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213,

Tel. +43 1 60 101, Fax. +43 1 60 101 1210

**Belarus:** Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6, 220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

**Belgium:** see The Netherlands **Brazil:** see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,

51 James Bourchier Blvd., 1407 SOFIA, Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,

Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,

72 Tat Chee Avenue, Kowloon Tong, HONG KONG, Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,

Tel. +45 32 88 2636, Fax. +45 31 57 0044 **Finland:** Sinikalliontie 3, FIN-02630 ESPOO, Tel. +358 9 615800, Fax. +358 9 61580920

France: 4 Rue du Port-aux-Vins, BP317, 92156 SURESNES Cedex,

Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,

Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,

Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Shivsagar Estate, A Block, Dr. Annie Besant Rd. Worli, MUMBAI 400 018, Tel. +91 22 4938 541, Fax. +91 22 4938 722

Indonesia: see Singapore

Ireland: Newstead, Clonskeagh, DUBLIN 14, Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053, TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007 Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3, 20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,

Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,

Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,

Tel. +60 3 750 5214, Fax. +60 3 757 4880

**Mexico:** 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905, Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,

Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,

Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

**Philippines:** Philips Semiconductors Philippines Inc., 106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI, Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

**Poland:** UI. Lukiska 10, PL 04-123 WARSZAWA Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain Romania: see Italy

Russia: Philips Russia, UI. Usatcheva 35A, 119048 MOSCOW,

Tel. +7 095 755 6918, Fax. +7 095 755 6919

**Singapore:** Lorong 1, Toa Payoh, SINGAPORE 1231, Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,

2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,

Tel. +27 11 470 5911, Fax. +27 11 470 5494

**South America:** Rua do Rocio 220, 5th floor, Suite 51, 04552-903 São Paulo, SÃO PAULO - SP, Brazil, Tel. +55 11 821 2333, Fax. +55 11 829 1849

**Spain:** Balmes 22, 08007 BARCELONA, Tel. +34 3 301 6312, Fax. +34 3 301 4107

**Sweden:** Kottbygatan 7, Akalla, S-16485 STOCKHOLM,

Tel. +46 8 632 2000, Fax. +46 8 632 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,

Tel. +41 1 488 2686, Fax. +41 1 481 7730

**Taiwan:** Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1, TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874

**Thailand:** PHILIPS ELECTRONICS (THAILAND) Ltd., 209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,

Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,

Tel. +90 212 279 2770, Fax. +90 212 282 6707

**Ukraine**: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7, 252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes, MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421 United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,

Tel. +1 800 234 7381

**Uruguay:** see South America **Vietnam:** see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,

Tel. +381 11 625 344, Fax.+381 11 635 777

For all other countries apply to: Philips Semiconductors, Marketing & Sales Communications, Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

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Printed in The Netherlands

117047/00/02/pp8

Date of release: 1997 May 29

Document order number: 9397 750 02161

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